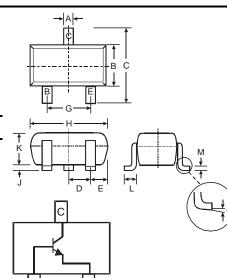


Features

- Epitaxial Planar Die Construction
- Complementary PNP Type Available (MMSTA92)
- Ideal for Low Power Amplification and Switching
- Ultra-Small Surface Mount Package
- Lead Free/RoHS Compliant (Note 2)
- "Green" Device (Note 3 and 4)

Mechanical Data

- Case: SOT-323
- Case Material: Molded Plastic, "Green" Molding Compound, Note 4. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminal Connections: See Diagram
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Marking Information: K3M, See Page 3
- Ordering & Date Code Information: See Page 3
- Weight: 0.006 grams (approximate)



| | SOT-323 | | | | | | | | | |
|----------------------|---------|--------|--|--|--|--|--|--|--|--|
| Dim | Min | Max | | | | | | | | |
| Α | 0.25 | 0.40 | | | | | | | | |
| В | 1.15 | 1.35 | | | | | | | | |
| С | 2.00 | 2.20 | | | | | | | | |
| D | 0.65 N | ominal | | | | | | | | |
| Е | 0.30 | 0.40 | | | | | | | | |
| G | 1.20 | 1.40 | | | | | | | | |
| н | 1.80 | 2.20 | | | | | | | | |
| J | 0.0 | 0.10 | | | | | | | | |
| К | 0.90 | 1.00 | | | | | | | | |
| L | 0.25 | 0.40 | | | | | | | | |
| М | 0.10 | 0.18 | | | | | | | | |
| α | 0° | 8° | | | | | | | | |
| All Dimensions in mm | | | | | | | | | | |

Maximum Ratings @T_A = 25°C unless otherwise specified

| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Collector-Base Voltage | V _{CBO} | 300 | V |
| Collector-Emitter Voltage | V _{CEO} | 300 | V |
| Emitter-Base Voltage | V _{EBO} | 6.0 | V |
| Collector Current (Note 1) | lc | 200 | mA |
| Power Dissipation (Note 1) | Pd | 200 | mW |
| Thermal Resistance, Junction to Ambient (Note 1) | R _{0JA} | 625 | °C/W |
| Operating and Storage Temperature Range | T _j , T _{STG} | -55 to +150 | °C |

В

Electrical Characteristics $@T_A = 25^{\circ}C$ unless otherwise specified

| Characteristic | Symbol | Min | Max | Unit | Test Condition |
|--------------------------------------|----------------------|-----|-----|------|---|
| OFF CHARACTERISTICS (Note 5) | | | | | |
| Collector-Base Breakdown Voltage | V _{(BR)CBO} | 300 | | V | $I_{\rm C} = 100 \mu A, I_{\rm E} = 0$ |
| Collector-Emitter Breakdown Voltage | V _{(BR)CEO} | 300 | _ | V | $I_{\rm C} = 1.0 {\rm mA}, I_{\rm B} = 0$ |
| Emitter-Base Breakdown Voltage | V _{(BR)EBO} | 6.0 | | V | $I_{\rm E} = 100 \mu A, I_{\rm C} = 0$ |
| Collector Cutoff Current | I _{CBO} | _ | 100 | nA | $V_{CB} = 200V, I_E = 0$ |
| Collector Cutoff Current | I _{EBO} | | 100 | nA | $V_{CE} = 6.0V, I_C = 0$ |
| ON CHARACTERISTICS (Note 5) | | | | | · |
| | | 25 | | | $I_C = 1.0 \text{mA}, V_{CE} = 10 \text{V}$ |
| DC Current Gain | h _{FE} | 40 | — | — | $I_{C} = 10 \text{mA}, V_{CE} = 10 \text{V}$ |
| | | 40 | | | $I_{C} = 30 \text{mA}, V_{CE} = 10 \text{V}$ |
| Collector-Emitter Saturation Voltage | VCE(SAT) | | 0.5 | V | $I_{C} = 20 \text{mA}, I_{B} = 2.0 \text{mA}$ |
| Base-Emitter Saturation Voltage | VBE(SAT) | | 0.9 | V | $I_{C} = 20 \text{mA}, I_{B} = 2.0 \text{mA}$ |
| SMALL SIGNAL CHARACTERISTICS | | | | | · |
| Output Capacitance | C _{cb} | | 3.0 | pF | $V_{CB} = 20V, f = 1.0MHz, I_E = 0$ |
| Current Gain-Bandwidth Product | f _T | 50 | _ | MHz | $V_{CE} = 20V, I_C = 10mA,$ f = 100MHz |

Notes: 1. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which

can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.

2. No purposefully added lead.

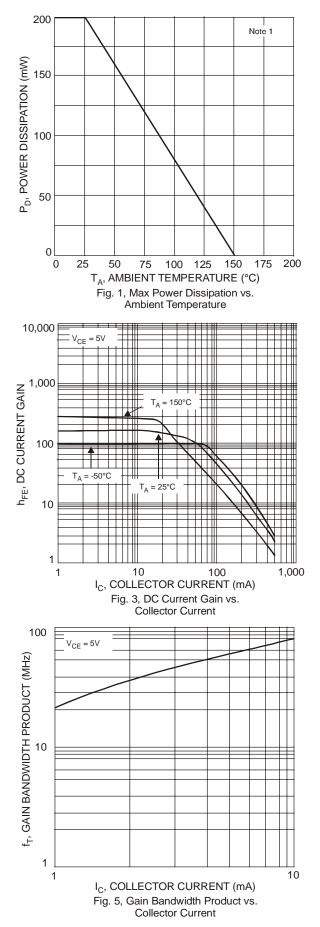
3. Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.

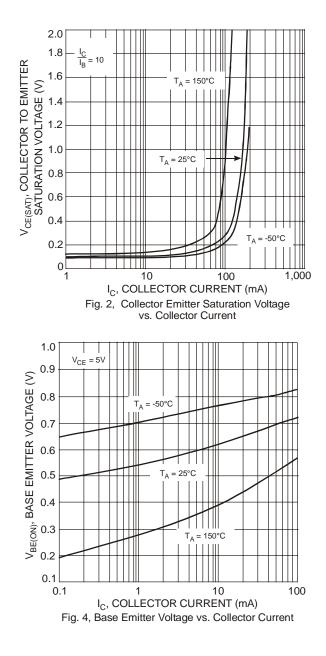
 Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

5. Short duration pulse test used to minimize self-heating effect.

Downloaded from Arrow.com.







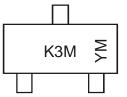


Ordering Information (Note 4 & 6)

| Device | Packaging | Shipping |
|-------------|-----------|------------------|
| MMSTA42-7-F | SOT-323 | 3000/Tape & Reel |

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



 $\begin{array}{l} \mathsf{K3M}= \mathsf{Product} \ \mathsf{Type} \ \mathsf{Marking} \ \mathsf{Code} \\ \mathsf{YM} = \mathsf{Date} \ \mathsf{Code} \ \mathsf{Marking} \\ \mathsf{Y} = \mathsf{Year} \ \mathsf{ex:} \ \mathsf{N} = 2002 \\ \mathsf{M} = \mathsf{Month} \ \mathsf{ex:} \ \mathsf{9} = \mathsf{September} \end{array}$

Date Code Key

| Year | 1998 | 1999 | 2000 | 2001 | 2002 | 2003 | 2004 | 2005 | 2006 | 2007 | 2008 | 2009 | 2010 | 2011 | 2012 |
|-------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|------|
| Code | J | К | L | Μ | Ν | Р | R | S | Т | U | V | W | Х | Y | Z |
| | | | | | | | | | | | | | | | |
| | | | | | | | | | | | | | | | |
| Month | Jan | Fe | b I | Mar | Apr | May | Ju | in | Jul | Aug | Sep | Oc | t I | Nov | Dec |

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